505417086 04/08/2019

## **PATENT ASSIGNMENT COVER SHEET**

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5463876

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
CHI-WEN KE	03/26/2019
CHI-HUNG CHUNG	03/26/2019

## **RECEIVING PARTY DATA**

Name:	CORETRONIC CORPORATION
Street Address:	NO. 11, LI-HSIN RD., HSINCHU SCIENCE PARK,
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16367267

## **CORRESPONDENCE DATA**

**Fax Number:** (949)391-4699

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 886223692800
Email: usa@jcipgroup.com

Correspondent Name: JCIPRNET

Address Line 1: P.O. BOX 600 TAIPEI GUTING
Address Line 4: TAIPEI CITY, TAIWAN 10099

ATTORNEY DOCKET NUMBER:	76693-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	04/08/2019

**Total Attachments: 2** 

source=76693\_asm#page1.tif source=76693\_asm#page2.tif

PATENT 505417086 REEL: 048824 FRAME: 0588

## ASSIGNMENT

WHEREAS.

1. Chi-Wen Ke

2. Chi-Hung Chung

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: PROJECTION SYSTEM, BEAM GENERATING APPARATUS THEREOF, AND BEAM GENERATING METHOD

[ ] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS 1. Coretronic Corporation

No. 11, Li-Hsin Rd., Hsinchu Science Park, Hsin-Chu 300, Taiwan,

R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have assigned and transferred, and by these presents does/do assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

# **ASSIGNMENT CONTINUED**

IN TESTIMONY WHEREOF,	Assignor has/have signed	d his/her/their name(s)	on the date(s)
indicated.			

Signature: Chi - Wen Ke Date: MAR 26 2019

Sole or First Joint Inventor: Chi-Wen Ke

Signature: Chi - Hung Chung Date: MAR 2 6 2019
Second Joint Inventor (if any): Chi-Hung Chung

-2-

PATENT REEL: 048824 FRAME: 0590